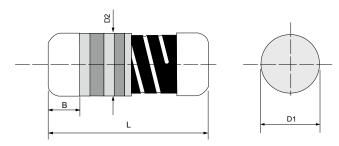


Cost-Down via Innovation

Quality • Reliability

MM(V) - Metal Film MELF **Resistor, Vehicle Grade**



Specifications Per

- IEC 60115-1
- EN140401-803
- AEC-Q200 Rev. D

Features

- AEC-Q200 Compliant
- Excellent solderability termination
- Products meet RoHS requirements and do not contain substances

of very high concern identified by European Chemicals Agency

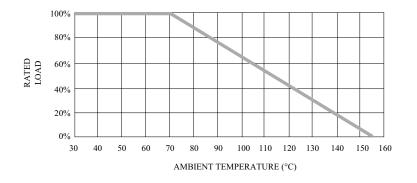
DIMENSIONS

Туре	Body Length (L, mm)	Cap Diameter (D1, mm)	Body Diameter (D2, mm)	Soldering Spot (B, mm)	Net Weight Per 1,000 pcs
MM204V	3.52 ± 0.15	1.35 ± 0.1	D1+0.02/ -0.15	0.6 Min.	17 grams
MM52V	5.90 ± 0.20	2.20 ± 0.1	D1+0.02/ -0.2	1.0 Min.	66 grams

GENERAL SPECIFICATIONS

Туре	Power Rating (At 70°C)	Maximum Working Voltage	Maximum Overload Voltage	Minimum Resistance	Maximum Resistance	Resistance Tolerance	Available Resistance Values
MM204\/	MM204V 1/4W 200V 400V	0.47Ω	10ΜΩ	±1%	E-24/ E-96		
1011012040		2000	400 V	0.4712	1010122	±2%, ±5%	E-24
MM52V	4/014/	1/2W 300V	500V	0.47Ω	10ΜΩ	±1%	E-24/ E-96
IVIIVI3ZV 1/.	1/200					±2%, ±5%	E-24

POWER DERATING CURVE



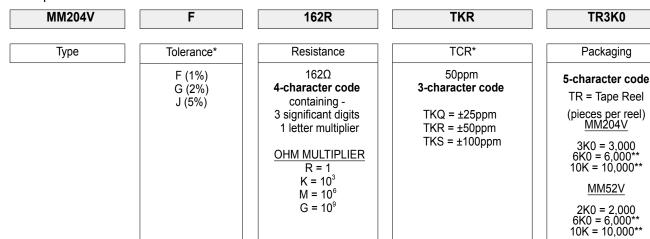


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MM(V) - Metal Film MELF Resistor, Vehicle Grade

MM(V)

PART NUMBER Example: MM204VF162RTKRTR3K0



* listed values may not be applicable across product types or to all resistance values. Please check with us before placing order. **upon request

TECHNICAL SUMMARY

Characteristics		Limits		
Operating Temperature Range,°C	-55 ~ +155			
Temperature Coefficient, PPM / °C*	±1%, ±2%	±25, ±50, ±100		
Temperature Coefficient, PPM / C	±5%	±100		
Dielectric Withotopoling Voltage VAC or DC	MM204V	300		
Dielectric Withstanding Voltage, VAC or DC	MM52V	500		
Insulation Resistance, MΩ	>104			
Tin Whisker (JESD201 Temperature Cycling &	-5	<5		
High Temp. /Humidity Storage), µm	<0			

* Not applicable to all resistance values. Please check with us regarding the PPM of specific resistance value(s).



MM(V) - Metal Film MELF Resistor, Vehicle Grade

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PERFORMANCE SPECIFICATIONS

Characteristics	Test Conditions	Limits		
Short Time Overload	IEC 60115-1 4.13	0.47Ω to 332KΩ	±0.25%	
	5 seconds 2.5x rated voltage (not over max. overload voltage) IEC 60115-1 4.24	>332KΩ	± 0.5%	
Load Life In Humidity	56 days rated load (not over max. working voltage) at (40±2)°C and (93±3)% relative humidity	$\begin{array}{c c} 0.47\Omega \text{ to } 332\text{K}\Omega & \pm 1.3 \\ \hline & > 332\text{K}\Omega & \pm 2.3 \\ \end{array}$		
Periodic Electric Overload	IEC 60115-1 4.39 3.9x rated voltage (not over max. overload voltage) with 0.1s ON, 2.5s OFF for 1,000 cycles	± 1.0%		
Resistance To Soldering Heat	IEC 60115-1 4.18.2 Dip the resistor into a solder bath measured (260±5)°C and hold it for a 10±1 seconds	± 0.5%		
Solderability	IEC 60115-1 4.17.2 Solder area covered after (235±3)°C/(2±0.2) seconds with flux applied	>95%		
Mechanical Shock	AEC-Q200 REV D. Stress NO.13 (refer to MIL-STD-202 Method 213 Condition C) Three shocks in each direction shall be applied along the three mutually perpendicular axes of the test specimen. Peak value: 100 g's, Duration: 6 ms, Velocity change: 12.3 ft/s, Wavefrom: Half sine	±0.5%		
Vibration	AEC-Q200 REV D. Stress NO.14 (refer to MIL-STD-202 Method 204) 5 g`s for 20 min., 12 cycles each of 3 orientations, Test from 10 - 2,000 Hz.	±0.5%	±0.5%	
	IEC 60115-1 4.25.1 Rated load (not over max. working voltage) 1,000 hours with 1.5 hours ON, 0.5 hours OFF, at (70±2)°C	0.47Ω to 332KΩ >332KΩ	±0.75% ±1.0%	
Load Life		0.47Ω to <1Ω	±2.0%	
	AEC-Q200 REV D. Stress NO. 3 (refer to MIL-STD-202 Method 108)	1Ω to 332KΩ	±1.5%	
	Condition D Steady State TA=125°C at derated continous working voltage. Measurement at 24±4 hours after test conclusion.	>332KQ	±2.5%	
	IEC 60115-1 4.37/ AEC-Q200 REV D. Stress NO. 7	0.47Ω to <100KΩ	±1.0%	
		100KΩ to 332KΩ	±2.5%	
	1,000 hours at 85°C and 85% relative humidity with 0.1x rated voltage (not over 100V)		±5.0%	
		0.47Ω to <332KΩ	±0.25%	
	IEC 60115-1 4.25.3	332KΩ to 1MΩ	±0.5%	
	1,000 hours at 85°C without load	>1MQ	±0.75%	
Thermal Endurance		0.47Ω to <332KΩ	$\pm 0.73\%$ $\pm 0.5\%$	
	AEC-Q200 REV D. Stress NO. 3 (refer to MIL-STD-202 Method 108)	332KΩ to 1MΩ	$\pm 0.3\%$ $\pm 0.75\%$	
	1,000 hours at 125°C without load	>1MΩ	± 1.0%	
	IEC 60115-1 4.19	± 0.5%		
Thermal Shock	-55°C 30minutes, +155°C 30 minutes, 5 cycles AEC-Q200 REV D. Stress NO. 4 (refer to JESD22 Method JA-104)	0.47 Ω to 332KΩ	± 1.0%	
	-55°C 30minutes, +125°C 30 minutes, 1,000 cycles 30min maximum dwell time at each temperature extreme. 1min. Maximum transition time.	>332KΩ	± 2.5%	
Single pulse high voltage overload	IEC 60115-1 4.27 5 pulses of 1.2/50µs at 10x rated voltage (not over max. overload voltage) with interval of 12 sec. 10 pulses of 10/700µs at 10x rated voltage (not over max. overload voltage) with interval of 60 sec.	± 0.5%		
Electrostatic discharge (Human body model)	IEC 60115-1 4.38 3 positive & 3 negative discharges with 2KV for MM204V or 4KV for MM52V (For continuous surge application please see Surge Performance paragraph)	± 2.0%		
Climatic test	IEC 60115-1 4.23 4.23.2 - dry heat: 16 hours 155° C 4.23.3 - damp heat: 24 hours 55° C with 95% relative humidity 4.23.4 - cold: 2 hours -55° C 4.23.5 - negative air pressure: 2 hour 8.5KPa at $(25^{\circ}$ C±10)^{\circ}C 4.23.6 - damp heat cyclic: 5 days 55° C with 95% relative humidity 4.23.7 - DC load: rated voltage at -55° C and 155° C each 1 Min.	± 1.0%		
Bending test	IEC 60115-1 4.33 Pressing depth 2mm, 3 times	± 0.25%		
Flammability	IEC 60115-1 4.35 Needle flame test 10s	No burning after 30s		

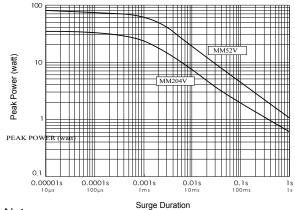


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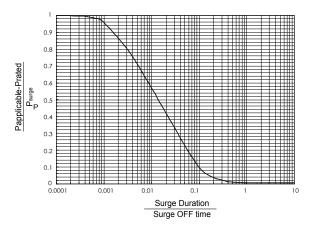
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SINGLE SURGE PERFORMANCE



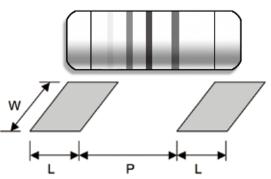
SURGE POWER DERATING CURVE



Notes:

- SINGLE SURGE PERFORMANCE graph is good for NON REPETITIVE applications operating in an ambient temperature of 70°C or less. For temperatures above 70°C, the graph power must be derated further linearly down to zero at 155°C.
- To determine applicable surge power in continuous-surge applications:
- 1. Identify allowable duration and peak power P_{surge} of single surge;
- 2. Determine ratio of surge duration/surge OFF time in application;
- 3. Calculate Papplicable backwardly according to Y-axis of SURGE POWER DERATING CURVE.

SUGGESTED PAD LAYOUT



Туре	Soldering Mode	Pad Length (L, mm, Min.)	Pad Spacing (P, mm)	Pad Width (W, mm, Min.)
MM204V	Reflow	1.3	1.6 ± 0.1	1.6
IVIIVI204V	Wave	1.5	1.5 ± 0.1	1.8
MM52V	Reflow	2.0	3.0 ± 0.1	3.0
	Wave	2.5	3.0 ± 0.1	3.0
For better heat dissipation / lower heat resistance, increase W & I				

COVER TAPE PEELING SPECIFICATION

Recommended peeling force: 50gf±5gf

